



DOCKET NO: 312302US40PCT

**IN THE UNITED STATES PATENT & TRADEMARK OFFICE**

IN RE APPLICATION OF :  
HUI ZHONG, ET AL. : EXAMINER: DINH, T.  
SERIAL NO: 10/049,270 :  
FILED: JUNE 27, 2002 : GROUP ART UNIT: 2841  
FOR: MULTILAYER PRINTED WIRING :  
BOARD, SOLDER RESIST  
COMPOSITION, METHOD FOR  
MANUFACTURING MULTILAYER  
PRINTED WIRING BOARD, AND  
SEMICONDUCTOR DEVICE

**AMENDMENT**

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated April 6, 2007, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.